

## **SSC8048GN6**

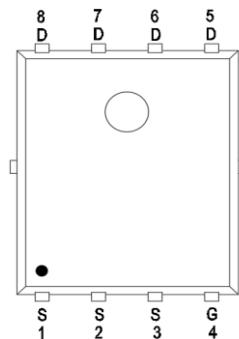
### N-Channel Enhanced MOSFET

#### ➤ Features

VDS	VGS	RDS(on) Typ.	ID
40V	$\pm 20V$	6.5mR@10V	60A
		8.2mR@4V5	

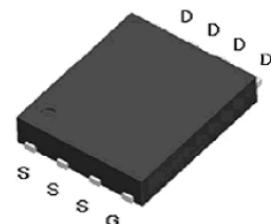
#### ➤ Pin configuration

Top view



#### ➤ Description

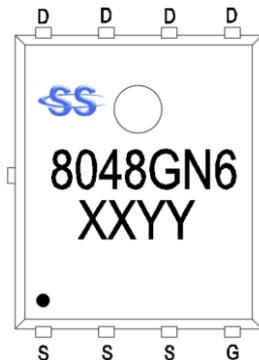
This device is N-Channel enhancement MOSFET. Uses advanced trench technology and design to provide excellent RDS(on) with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. 100% UIS + DVDS Tested.



PDFN5X6

#### ➤ Applications

- DC/DC converters
- Power supplies
- Motor Drive Control
- Synchronous rectification



Marking

(XX: product year / YY: product week)

#### ➤ Ordering Information

Device	Package	Shipping
SSC8048GN6	PDFN5X6	5000/Reel

➤ **Absolute Maximum Ratings( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
$V_{DSS}$	Drain-to-Source Voltage	40	V
$V_{GSS}$	Gate-to-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current <sup>d</sup>	$T_c=25^\circ\text{C}$	60
		$T_c=100^\circ\text{C}$	37
$I_{DSM}$	Continuous Drain Current <sup>a</sup>	$T_A=25^\circ\text{C}$	26
		$T_A=70^\circ\text{C}$	17
$I_{DM}$	Pulsed Drain Current <sup>b</sup>	180	A
$P_D$	Power Dissipation <sup>c</sup>	$T_c=25^\circ\text{C}$	40
		$T_c=100^\circ\text{C}$	16
$P_{DSM}$	Power Dissipation <sup>a</sup>	$T_A=25^\circ\text{C}$	4.6
		$T_A=70^\circ\text{C}$	2.9
$I_{AS}$	Avalanche Current <sup>b</sup> L=0.5mH Single Pulse	23	A
$E_{AS}$	Avalanche Energy <sup>b</sup> L=0.5mH Single Pulse	132	mJ
$T_J$	Operation junction temperature	-55~150	$^\circ\text{C}$
$T_{STG}$	Storage temperature range	-55~150	

➤ **Thermal Resistance Ratings( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance <sup>a</sup>	27	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Junction-to-Case Thermal Resistance	3.1	

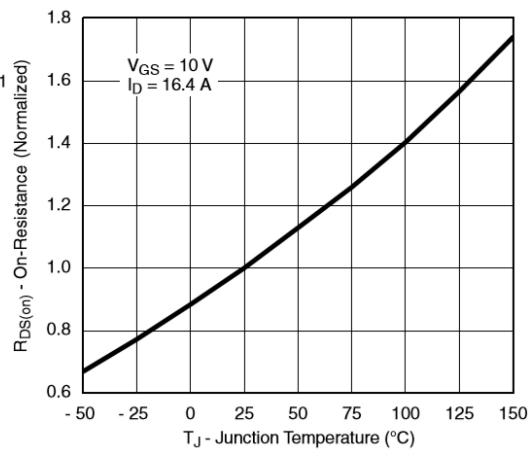
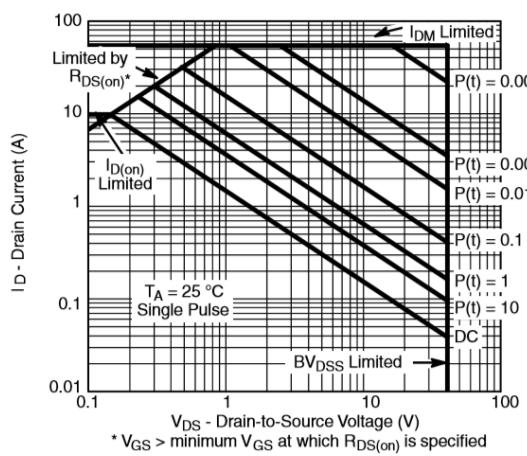
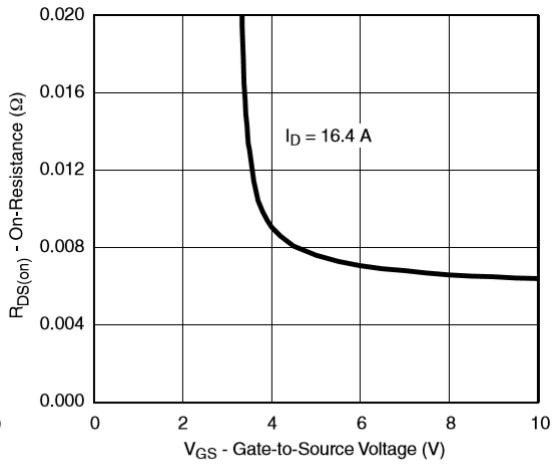
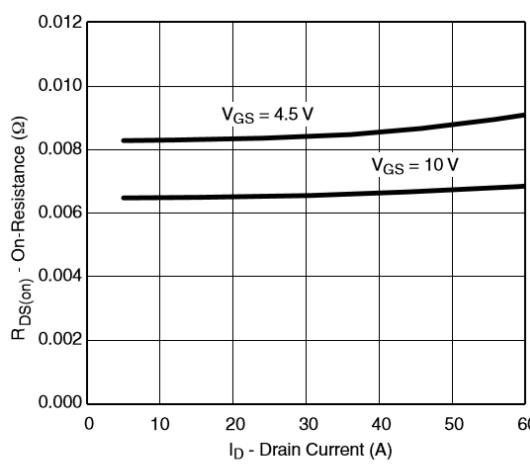
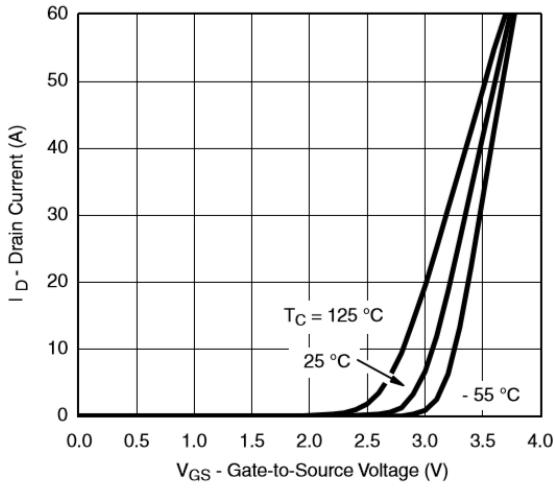
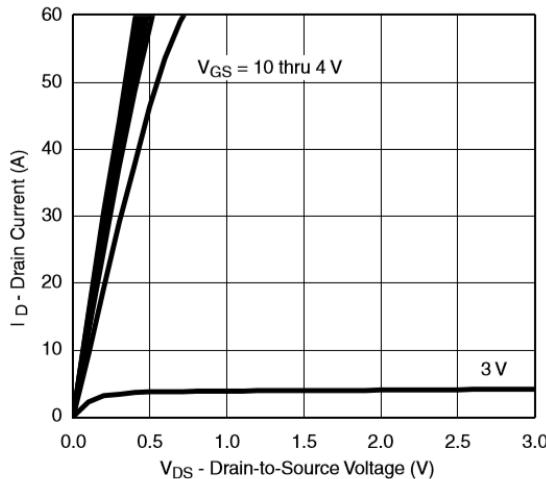
Note:

- a. The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user specific board design. The power dissipation is based on the t  $\leq 10\text{s}$  thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation  $P_D$  is based on  $T_{J(MAX)}=150^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

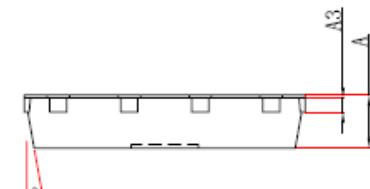
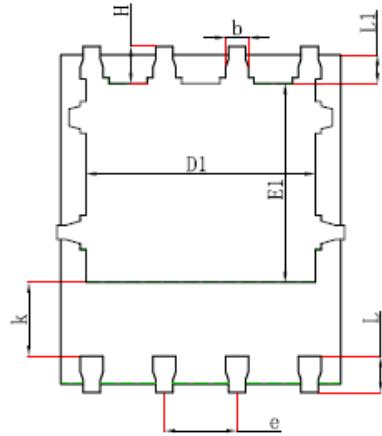
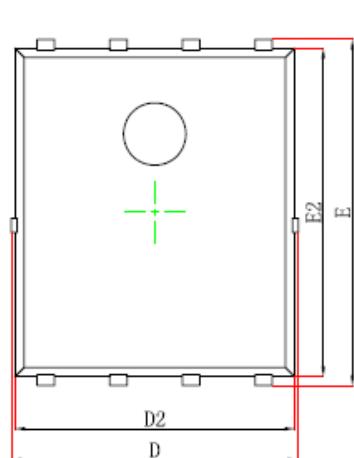
➤ Electronics Characteristics( $T_A=25^\circ C$  unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, ID=250\mu A$	40			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, ID=250\mu A$	1.2	1.8	2.5	V
$R_{DS(on)}$	Drain-Source On-Resistance	$V_{GS}=10V, ID=30A$		6.5	8	mR
		$V_{GS}=4.5V, ID=20A$		8.2	12	
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=32V, V_{GS}=0V$			1	uA
$I_{GSS}$	Gate-Source leak current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
$G_{FS}$	Transconductance	$V_{DS}=5V, ID=20A$		30		S
$V_{SD}$	Forward Voltage	$V_{GS}=0V, IS=20A$		0.8	1.3	V
$R_g$	Gate Resistance	$V_{DS}=0V, f=1MHz$		1.1		R
$C_{iss}$	Input Capacitance	$V_{DS}=20V, V_{GS}=0V, f=1MHz$		2860		pF
$C_{oss}$	Output Capacitance			120		
$C_{rss}$	Reverse Transfer Capacitance			50		
$T_{D(ON)}$	Turn-on delay time	$V_{GS}=10V, RL=2.5R$ $V_{DS}=20V, RG=4.7R$		12		ns
$T_r$	Rise time			10		
$T_{D(OFF)}$	Turn-off delay time			33		
$T_f$	Fall time			11		
$Q_G$	Total Gate Charge	$V_{GS}=10V, V_{DS}=20V$ $ID=20A$		43		nC
$Q_{GS}$	Gate Source Charge			6.2		
$Q_{GD}$	Gate Drain Charge			6.5		
$T_{rr}$	Diode Recovery Time	$IF=10A, di/dt=100A/us$		30		ns
$Q_{rr}$	Diode Recovery Charge	$IF=10A, di/dt=100A/us$		26		nC

➤ **Typical Characteristics**( $T_A=25^\circ\text{C}$  unless otherwise noted)



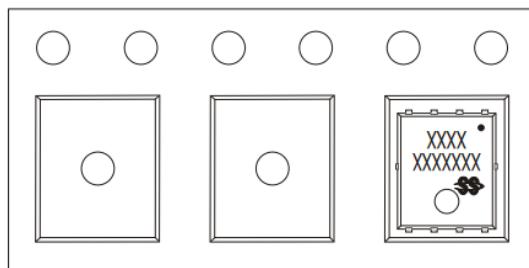
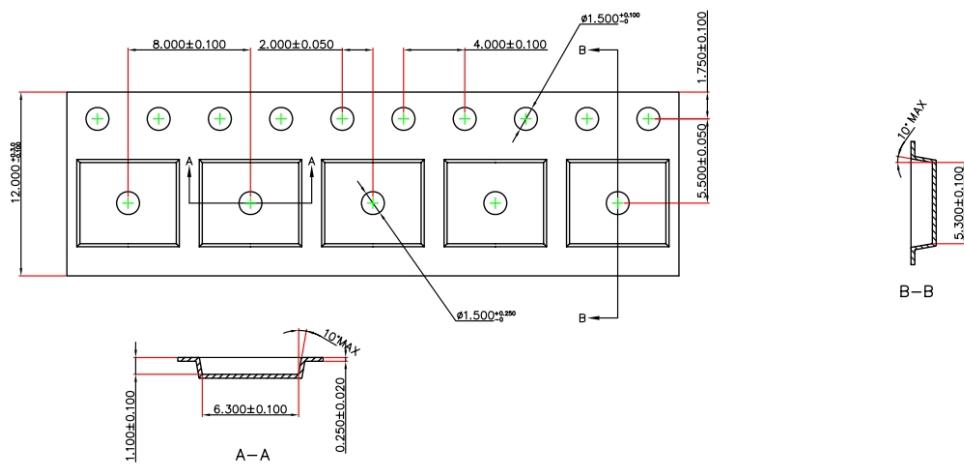
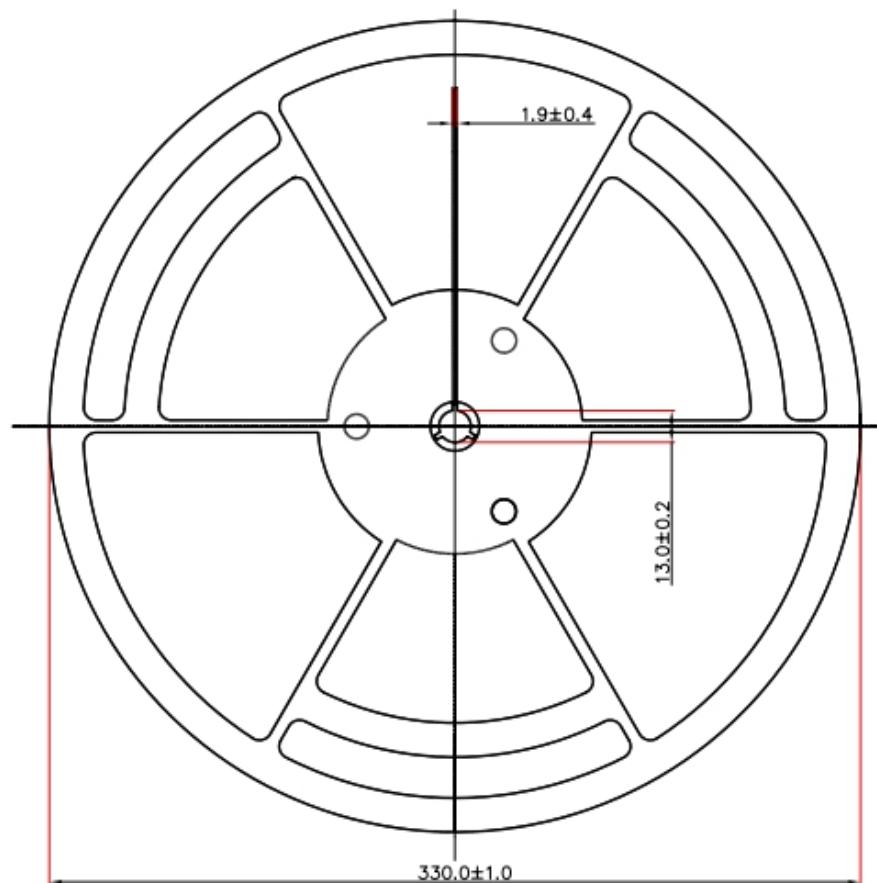
➤ Package Information



Package: PDNF5X6-8L

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254REF		0.010REF	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP		0.050TYP	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°

## ➤ Tape and Reel





**SSC8048GN6**

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